

# COMPUTER SERVICE TECHNOLOGY, Inc.

## **SP 3000** **DDR3 Memory Tester** **240pin DIMM** **1333 / 1066 / 800 MHz**



### **SP3000 DDR3 1333 240pin** **DIMM Manual – Revision 6**

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## Warranty

All components used in CST product are of the highest commercial grade available. Furthermore, each product is subjected to a very rigid test program during and after assembly and prior to shipment. Nevertheless, as with all components and equipment, there could be a certain small percentage of failure.

CST, Inc. warrants for a period of one (1) year from the date of purchase by the original customer, all products manufactured by it, to be free under normal use and service from defects of material and workmanship. During this period, if the product unit is determined to be defective, return it to your original place of purchase. They will promptly, at their option, repair or replace the defective unit.

This warranty shall not apply to any consumable parts beyond its expected usable life cycle specified in the specification section. This warranty shall not apply to any product which has been repaired or altered in any manner by anyone other than CST, Inc., or products which have been connected, installed, used or otherwise adjusted other than in accordance with written instructions furnished by CST, Inc.

The above warranty shall not apply to defects resulting from improper or inadequate maintenance by customer, or operation outside of the environmental specifications for the products. The above warranty shall not be extended beyond its original term with respect to any part or parts repaired or replaced by CST, Inc. No person, including any dealer, agent or representative of CST, Inc. is authorized to assume for CST, Inc. any obligation or liability other than expressly stated here. CST, Inc. does not assume any liability for incidental, special and/or consequential damage of any kind whatsoever, and in any event, liability shall in no case exceed the original price of the product.

Implied warranties, including, without limitation, warranties of merchantability or fitness, are expressly limited in duration to the one- (1) year specified above. Certain terms and conditions of the warranty may not apply where local laws prevail.

## General Safety

Review the following safety precautions to avoid injury and prevent damage to this product or any products connected to it. To avoid potential hazards, use the product only as specified. Only qualified personnel should perform service procedures

### Injury Precautions

- |   |   |
|---|---|
| <b>Use proper Power Cord</b>                  | : To avoid fire hazard, use only the power cord specified for this product  |
| <b>Avoid Electric Shock</b>                   | : To avoid injury or loss of life, do not removed front panel and try to retrieve any components or try to fix any defects, without a qualified personnel. Do remember to shut down any power source, if products are under maintenance.  |
| <b>Ground the Product</b>                     | : This product is grounded through the grounding conductor of the power cord. To avoid electric shock, the grounding conductor must be connected to earth ground. Before making the connections to the input or output terminals of the product, ensure that the product is properly grounded |
| <b>Do not operate without cover:</b>          | To avoid electric shock or injury, do not operate this product with safety covers or panels removed.  |
| <b>Do not operate in Wet/Damp Conditions:</b> | To avoid electric shock, do not operate this product in wet/damp conditions   |

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## *Notice*

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If you required further assistance with this product, please contact CST, Inc. technical support hot line or authorised representative.

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Website : [www.simmtester.com](http://www.simmtester.com)

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## 1. Unpacking and Inspection

Every precaution has been taken to ensure that the product reaches you in fully operational condition. If there are any damaged to the packaging, or to the product, it should be returned to the shipper and CST, Inc. should be notified immediately.

Upon unpacking, inspect the unit for any obvious physical damage, such as broken display indicators, buttons and connectors, etc. If any damage is evident, return it to CST, Inc. or to any authorized representative for repair or replacement. Please keep carton box, foam packaging material and plastic bags in the event that the unit has to be returned to CST.



### SP3000 DDR3 Tester Accessories



## 2. The SP3000 Memory Tester

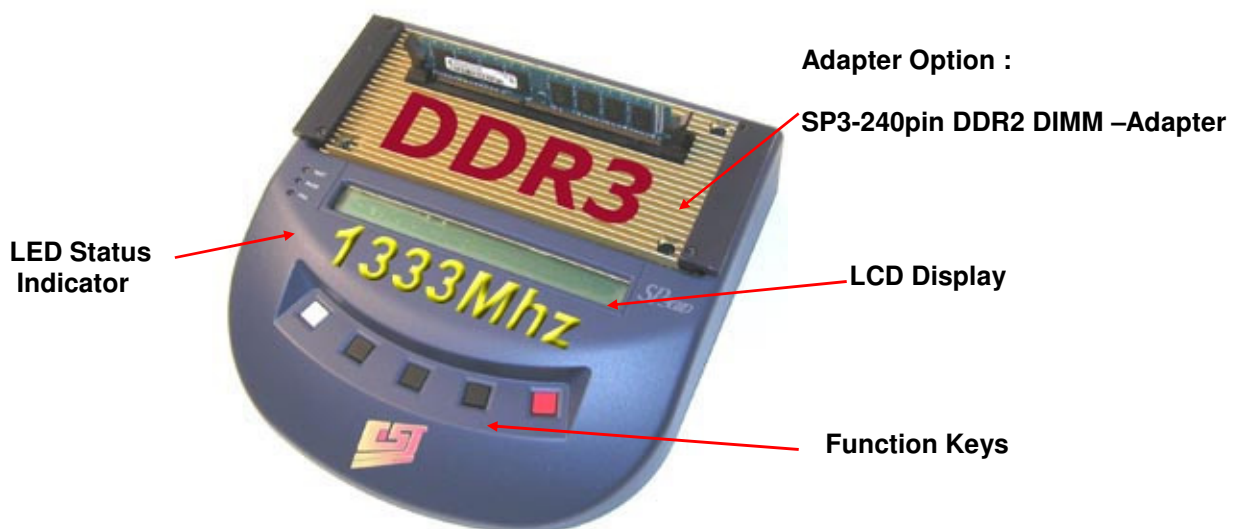
The **SP3000** - is a new generation of Memory Testers from CST, Inc. It is built with state-of-the-art technology to fit the memory testing needs of the computer service industry. The compact, portable and stand-alone **SP3000** with the proper optional adapters is capable of testing the standard DRAM, page mode and EDO access mode 72 pin SIMM & 168 pin SDRAM DIMM, with optional adapter it has ability to test DDR2,DDR1, SODIMM & PCMCIA type of modules and many. All these tests are performed on the same base tester with optional plug and Test Adapter. Designed with the service professionals in mind, and coupled with the knowledge of the future memory market trends and demands, the **SP3000** is the Memory Testers with the future built-in.

The automatic identification detection feature allows user to identify the module's configuration in seconds. Special settings are not needed, - just insert the module and press a function key! The results include memory size; structure, type and speed are clearly displayed on the LCD. The testers can also provide a group of standard test devices for you to test with or if you prefer, you can customize your test and save it in the tester, so you won't lose the data even the tester is power down.

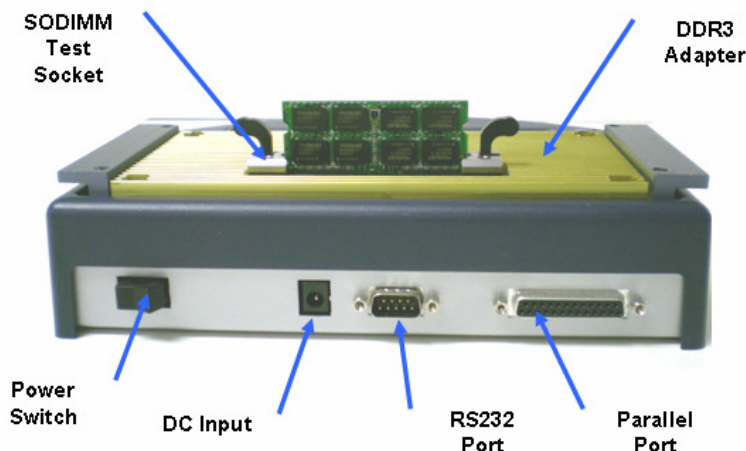
The **SP3000** have been carefully planned and designed to be affordable while providing maximum upgrade ability for today and tomorrow's needs. Their modular expansion adapter can accommodate future memory testing needs with ease at an affordable cost. At the same time your investment in to the tester is protected from obsolescence.

The **SP3000** is a cost-effective solution for service professionals especially in incoming inspection, engineering, field service, depot support, system integrators, resellers, system/subsystem manufacturers and any industry where memory is used.

### 2.1 SP3000 Product overview



## Rear Panel



This chapter highlights the key features of the **SP3000-DDR3 DIMM Tester**. Hardware and software are covered in this section.

## 2.2 System Hardware

Light weight, portable universal stand-alone memory tester.

- Easy to use.
- Uses a powerful & high speed Motorola micro-controller to manage the I/O task (such as LCD Display, function keys, printer ...etc).
- An allocated system storage space is used to save the test parameter, erasable and programmable, data will not be lost even when the power is down.
- The interface to the device under test utilized sophisticated customized designed chips, for easy error detection of problematic modules.
- 2 lines by 40 alphanumeric characters LCD display shows clear instructions and test results.
- Test results can be printed to printer through the on-board parallel port.
- Optional PC interface kit enable testing through PC control software.
- 5 programmable function keys are included for all the menu options.

### DDR2 Test Adapter Available:

- SP3-240pin DDR2 DIMM Adapter (1066/ 800 / 667 / 533/ 400 MHz)
- SP3-200pin DDR2 SODIMM Adapter (800/667/ 533 / 400 MHz)
- SP3-DDR2 BGA Chip Adapter (800/667/533/400Mhz)
- SP3-DDR2 BGA POGO Pin Chip Adapter (800/667/533/400Mhz)

### DDR Test Adapter Available:

- SP3-184pin DDR DIMM Adapter (500 / 400 /333 / 266 / 200 MHz)
- SP3-184pin DDR DIMM Adapter (440 / 400 / 333 / 266 MHz)
- SP3-200pin DDR SODIMM Adapter (400/ 333/266/200 MHz)
- SP3- 66pin DDR TSOP Chip Adapter (333/266/200 MHz)

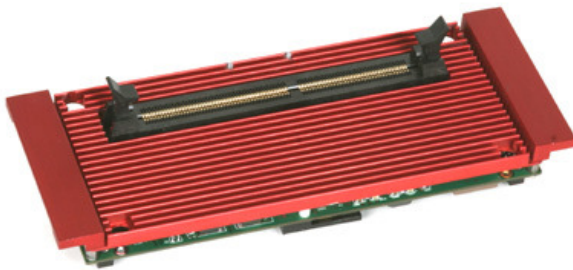


**SDRAM Test Adapter Available:**

- SP3-168pin SDRAM DIMM Adapter (133MHz Max)
- SP3-168/144 pin SDRAM DIMM/SODIMM Adapter (133MHz Max)
- SP3-100 pin SDRAM DIMM Adapter

**Other Test Adapter Available:**

- SP3-72/168 pin DRAM SIMM/DIMM Adapter
- SP3-30/72/168 pin DRAM SIMM/DIMM Adapter
- SP3- 144pin SGRAM Adapter
- SP3- 72/144pin DRAM SODIMM Adapter
- SP3-100pin DRAM DIMM Adapter
- SP3- Sun SPARC 200pin Adapter
- SP3-PCMCIA DRAM Card Adapter



**SP3- DDR 400Mhz Adapter**



**SP3- DDR2 800 MHz Adapter**

## 2.3 Specifications

<b>Memory Type</b>	<b>240 Pin DDR3 DIMM SDRAM</b>
<b>Module Type</b>	<b>PC3-6400, PC2-8500 , PC3-10666</b>
<b>DIMM Pin-out</b>	<b>240pin Unbuffered DIMM &amp; RDIMM</b>
<b>Module Density Limit</b>	<b>512, 1,2,4,8 &amp; 16 GB</b>
<b>Test Clock Frequency</b>	<b>400,533 &amp; 667mhz Clock , 5 mhz increment</b>
<b>Memory Data-Rate</b>	<b>800 ,1066 &amp; 1333 Mhz</b>
<b>Address Depth</b>	<b>4 GB address field up to 16 row &amp; 12 column</b>
<b>Data Bit Width</b>	<b>64 &amp; 72</b>
<b>Control Lines</b>	<b>1-RAS, 1-CAS, 4-CS , 2-CKE, 9-DOS, 9-DOM</b>
<b>Variable Test Voltage</b>	<b>Vdd = 2.0, 1.9, 1.8 , 1.7, 1.6 , 1.5 1.4 &amp; 1.35 V</b>
<b>Variable AC Parameters</b>	<b>CAS Read Latency = 5 ,6 ,7,8,9</b> <b>TRCD = 5 ,6 ,7,8,9</b> <b>TRP = 5 ,6 ,7,8,9</b> <b>AL = 0,1,2,3,4</b> <b>CAS Write Latency = 5,6,7,8,9</b> <b>Refresh : 8 ,16,32 ,64 &amp; 128 us (Self &amp; CBR)</b>
<b>Test Pattern</b>	<b>Assembly Check :</b> Walk Data , Walk Address , Chk_CS, Chk_CKE, Chk_DQS, Chk_DQM, & SPD_Address Test.  <b>Functional :</b> Mat-S, Mar_X , Mar_C , Mar_Y , Mov-I  <b>Programming :</b> SPD Read , SPD Write, CRC Checksum Auto calculation

### Power Requirements

- Power Adapter : Input 100 - 250Vac  
Frequency - 50 - 60 Hz  
Output - 12V @3A

### Operating Temperature

- 32° F to 100° F ( 0° C to 60° C )

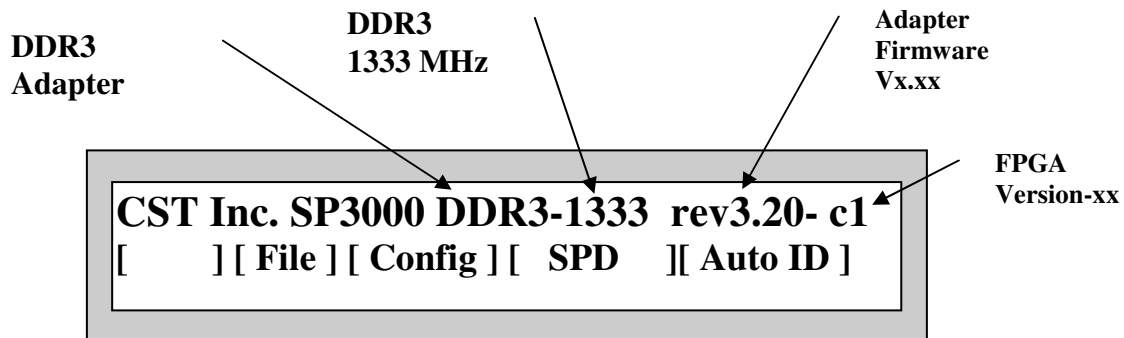
### Physical Dimension

- L x W x H : 9.30" x 9.25" x 2.00" (236mm x 235mm x 51 mm)
- 6 lbs. ( 3 Kg )

### 3. Operating Basics

This chapter guides you through the **SP3000 DDR3** test system basic menu operation. The SP3-204-DDR3- SODIMM Adapter is required to be attached to the base SP3000 Tester for DDR3 SODIMM Module Testing.

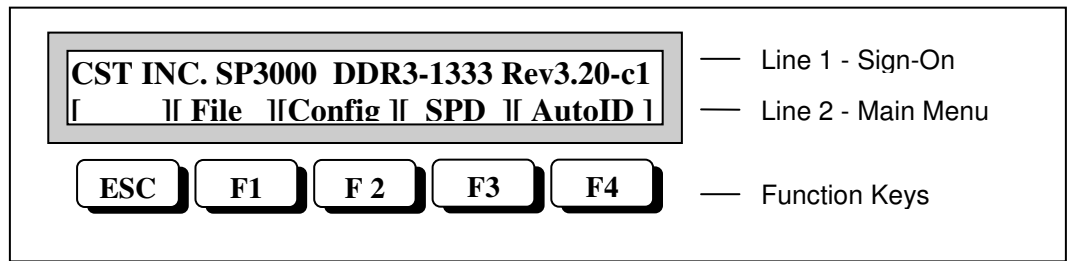
- Unpack the tester from the box
- Connect the DC Power adapter to the SP3000 Tester.
- Plug-on the required Test Adapter to the SP3000 Tester.
- Switch off “Power” before changing a different test adapter.
- Turn on the Power Switch at the rear of the tester.
- A Sign-On Message will be displayed on the LCD.



- The SP3000 tester is ready for testing the DDR3 DIMM module!

#### **CAUTION:**

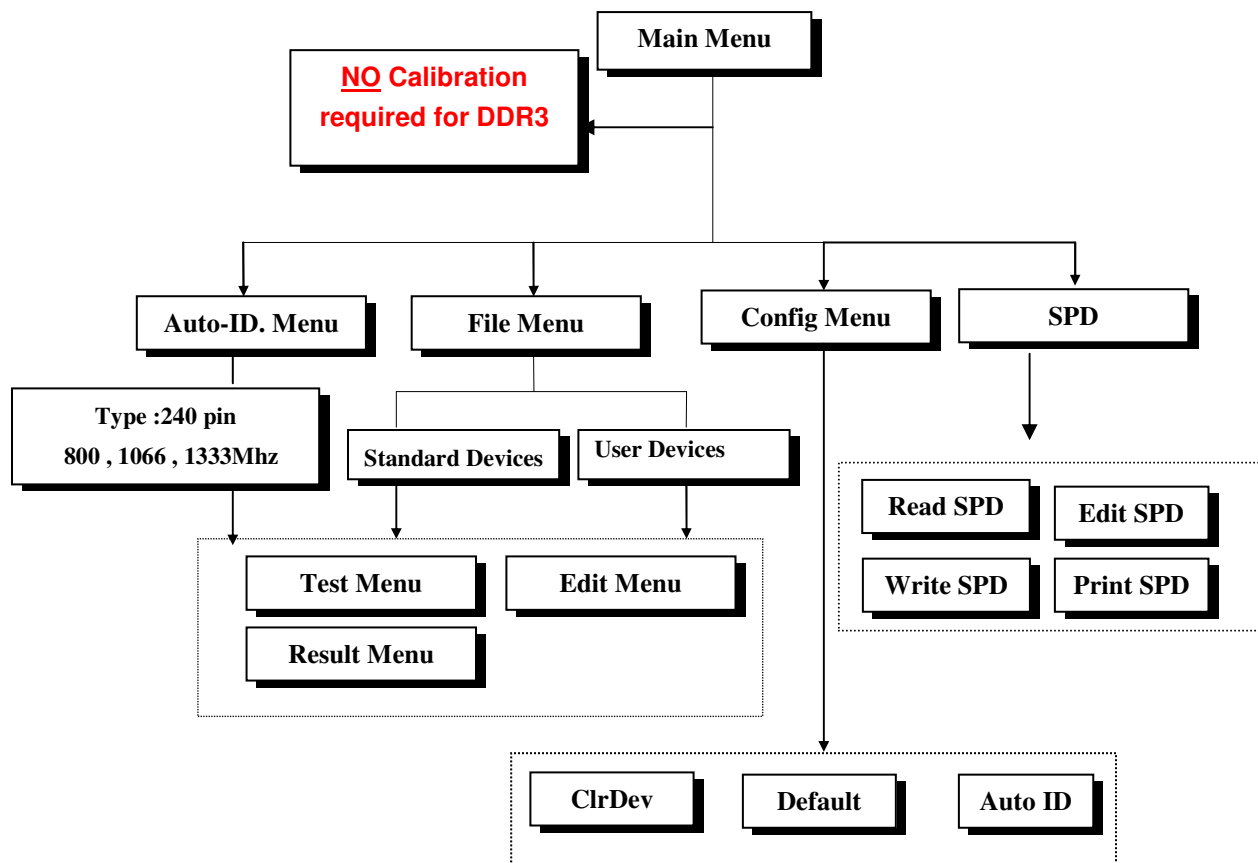
Ensure the Power is turned off before removing or replacing Test Adapter or Test Socket.  
If the above LCD screen message does not appear, the adapter firmware may be corrupted



### Basic SP3000 DDR3 Test Screen

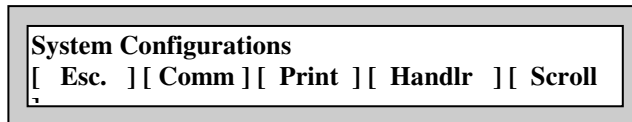
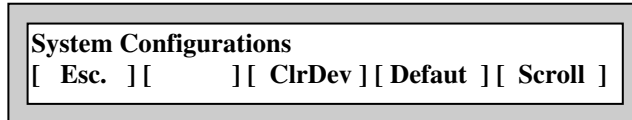
The 2nd line on the LCD display usually denoted as the key functions corresponding to the key buttons in-line below the display.

### Basic Menu Organization

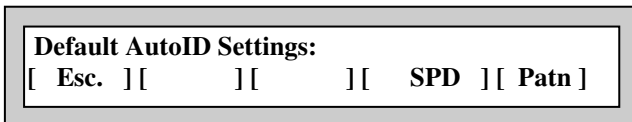
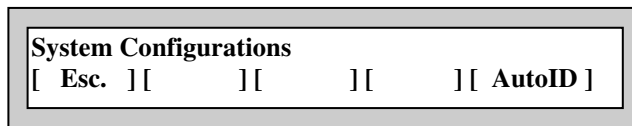


### 3.1 Configuration Menu setting

The **[Config]** Configuration menu allows selection for the following system configuration setting:



Selecting [Scroll] brings up this Menu



Return to **Main Menu**.

Press **[ ClrDev ]** key, bring up the **Clear Device** Menu [ Clears all stored device file from SP3000 base tester.

Press **[ Default ]** key , bring up the **Default** setting Menu [ Clears ] previous pattern setting and resets test pattern at factory setting – walk address, walk data & mat-s]

Press **[ Comm ]** key, bring up the **Com Port** Menu. [ Set RS232 communication baud rates ]

Press **[ Print ]** key, bring up the **Printer** Menu. [ Select printer form feed format when printer is connected directly to SP3000 printer port ]

Press **[ Handlr ]** key to bring up the **Handler** setting Menu [ Function to enable or disable Handler mode, for manual testing ensure – Handler is turn OFF ]

Press **[ Scroll ]** key, to bring up the **Default Auto-ID Setting Menu**

#### 3.1.1 Clear Device Menu.

This menu enable user to clear out previous old device library stored in the SP3000 base tester, the **SP3-DDR3 adapter** enable user to create and store up to 8 users define device library.

#### 3.1.2 Default Menu.

This menu enable user to quickly restore test pattern setting including the burst-length to its factory default setting. When the default key is selected, the following test pattern is set as a default:

- Walk address, Walk data . Mat\_S,

### 3.1.3 Com Port Menu.

This menu enable user to redefine the baud rate between the PC and SP3000. When user opt to use the PC to display the SP3000 screen output or for performing a Firmware update, the SP3000 Tester can connected to any PC's Com port with the use of a Serial Cable. An Advanced PC software will be required to communicate with the SP3000 tester  
When **[Comm]** Menu is activated:

<b>Baud rate = 19200</b> [ Esc. ] [        ] [        ] [ Toggle ] [ OK ]
--

Press **[ Esc. ]** key, return to **Main Menu**.

Press **[ Toggle ]** key, edit the baud speed setting . Baud-rate setting available are 19200, 9600, 4800 , 2400 & 1200.

Press **[ OK ]** key, return to the System Configuration menu

**Factory default Baud Rate setting is 19200.**

### 3.1.4 Print Menu.

The **[Print ]** function enable the selection of paper or form feed to the printer connected.

<b>Form Feed : Yes</b> [        ] [        ] [        ] [ F.F. ] [ OK ]
--

**[ F.F. ]** key, toggles the Form Feed between Yes or No

**[ OK ]** key, return to the System Configuration menu

### 3.1.5 Handler Menu.

The **[Handler]** function allow the user to enable or disable the Handler control when interface with any CST 's RoboFlex2 Automatic Handler System.

<b>Handler : Off , Sort : 1000 ms</b> [ On ] [ --- ] [ + 1 s ] [ +.1s ] [ OK ]
---

### 3.1.6 Default Auto-Id Settings :

The **[ Default Auto ID Settings ]** function enable user to pre-select the default test patterns during the Auto-ID stage. The default test pattern can be used, when the selected test pattern is activated. The user may edit the default test pattern by using the Edit function key for that particular test routine.

<b>Default AutoId Settings :</b> [ Esc. ] [        ] [        ] [ SPD ] [ Patn ]
---

**[ Esc ]** - Returns to System Configuration menu

- [ **Patn** ] - The [ **Patn** ] or **Pattern** function brings out the following test patterns which user can define as defaults test patterns to be used whenever a module is selected to be Auto-ID or tested.

<b>WA+WD+Mt+</b> [ Esc ] [ <b>Basic</b> ] [ <b>Custom</b> ] [ <b>Burst</b> ] [     ]
---

- [ **Basic** ] - The **Basic** function select only Walk Address and Walk Data default test. This is the quickest test ( 2 seconds) for checking opens and shorts. Basic test checks for assembly problem and may not capture DRAM cell problems

- [ **Burst** ] - The **Burst** function enable user to select the burst type [ Sequential or Interleave mode ] and burst length [ 4 & 8 ]. Setting the burst length with 8 will speed up the test time.

- [ **Custom** ] - The **custom** function brings out the following test patterns which user can select as default. Custom pattern setting can be saved in either the SP3000 base tester or transfer to PC for storage and recall later for testing

[ x ] w_Addr    [ x ] w_Data    [ x ] MatS [ Toggle ] [ <-- ] [ --> ] [ OK ]
---

[   ] Mar_x   [   ] Mar_C   [   ] Mar_Y   [   ] MovI [ Toggle ] [ <-- ] [ --> ] [ OK ]
---

[   ] chk_CS   [   ] chk_CKE   [   ] chk_DQM   [   ] [ Toggle ] [ <-- ] [ --> ] [ OK ]
---

[   ] spdRC   [   ] spd_addr   [   ] [ Toggle ] [ <-- ] [ --> ] [ OK ]
---

#### For Assembly Checks

- **W\_data** : Walk Data pattern are used to detect shorts in the Data lines of the module.
- **W\_addr** : Walk Address pattern are used to detect shorts on the address lines of the SODIMM module including BA 0 and BA1.
- **Chk\_C.S**: Chip Select are used to check for assembly shorts and open on the four CS pins ( CS 0 ,1,2 & 3) of the DIMM module.
- **Chk\_CKE** : CKE test are to use to check for open and short of CKE0 and CKE1 on the DIMM module.

- **Chk\_DQM** : DQM test are to used to check for open and short on the 9 DQM pin ( DQM 0 – 8) on the DIMM module
- **Check SPD\_Addr** : SPD Address Test are used to check for shorts and open on SDA 0,1,2

### For Functional Test

The following abbreviations are types of functional failures below:

AF – address decoder fault  
 B – number of bits (cells) in the memory word  
 CF – coupling faults  
 CFdyn – dynamic CF  
 CFid – idempotent CF  
 CFin– inversion CF  
 SAF – stuck at fault  
 SCF – state coupling fault  
 TF – transition fault  
 W – write operation

- **Mar\_S Test** : (Modified Algorithmic Test Sequence +), is a short test that detects all unlinked SAFs and AFs failures.
- **Mar\_X Test** : This March X test is used to test for Cfin , Afs, SAFs and TFs not linked with Cfin.
- **Mar\_C Test** : This March C test is used to test for unlinked CFins , Cfids, Cfdyns, Afs, SAFs and TFs.
- **Mar\_Y Test** : This March Y test is used to test for linked CFins , Afs, SAFs and TFs linked with CFins.
- **Mov\_I Test** : This Moving Inversion test is used to test for unlinked Cfids, Afs, SAFs,TFs.

### For SPD Read and Write Test

- **SPD\_RC** : SPD Read Data Test runs the SPD test based on the configuration defined in the SPD menu. Byte 0-255 from SPD EEPROM is compared with SPD Data stored in Buffer. The SPD test can be executed in the same cycle after the rest of the test pattern is completed when activated.
- **SPD\_WRC** : SPD Write and compare Data Test – writes data into Byte 0-255 on the DIMM Blank SPD EEPROM and compared with SPD Data stored in Buffer. When SODIMM SPD EEPROM does not match Buffer Data , tester will fail SPD Data test. The SPD test can be executed in the same cycle after the rest of the test pattern is completed when activated.
- **SPD CRC Checksum calculation ( Byte 126-127) is offered as a standard feature for DDR3 SPD programming.**



### 3.1.7 SPD Setting ( Default)

[ **SPD** ] - The [ **SPD** ] function are used for the following SPD setting which user can define as defaults SPD parameters to be used whenever a module is selected to be programmed.

**Default Auto-Id Settings :**

[ **Esc.** ] [ **SPD** ] [ **Patn** ]

Press [ **SPD.** ] key, return to change SPD setting

**WRT Page Length = 4**

[ **Esc.** ] [ **←** ] [ **→** ] [ **OK** ]

Press [ **---->** ] key, to change the Write Page length setting to : 1, 4, 8 & 16 bytes  
Page length setting is dependent on the specification of the EEPROM. SPD Programming time can be speed up with a higher byte length setting, check the EEPROM manufacturer specification to determine the appropriate page length setting. CST recommends Page Length 4 to support most EEPROM.

Press [ **---->** ] key, to *Specify SPD Read/Write Range [ Typical 0 –255]*

**SPD Read : 000 => 255**

[ **Esc.** ] [ **Toggle** ] [ **←** ] [ **→** ] [ **OK** ]

**SPD Write : 000 => 255**

[ **Esc.** ] [ **Toggle** ] [ **<-----** ] [ **----->** ] [ **OK** ]

Press [ **---->** ] key, to *Mask Out Byte 120 - 125 which is used for programming serial number and date codes. This bytes are unique number and ignore during SPD data comparing.*

**Mask Out Byte 120-125 ? : Yes**

[ **Esc.** ] [ **No** ] [ **OK** ]

**Read Cmp** : enable user to compare SPD data with the SPD data saved in the file or from the SP3000 tester buffer, NO SPD rewrite is possible for this mode selection.

**SPD\_Data\_Test allowed: RD\_Cmp**

[ **Esc.** ] [ **<-----** ] [ **---->** ] [ **OK** ]

**WR Cmp** : Allow user to compare SPD data with the SPD data saved in the tester's buffer, and allow SPD rewrite after passing all functional test. Be careful when

selecting this function. The original SPD data from the DIMM EEPROM will be overwritten.

```
SPD_Data_Test allowed: WR_Cmp
[ Esc. ] [      ] [ <----- ] [ ----> ] [ OK ]
```

**For permanent & reversible write protect setting, read chapter 4. 5 page 39 for details**

## 3.2 Auto ID Menu

The automatic identifying (Auto-ID) device functions, allow user to determine the configuration, size, speed..... etc of the unknown module under test. The following parameters will be determined:

- Device Operating Voltage – VDD: 1.5V
- Rows configuration
- Columns configuration
- Number of data lines
- Number of banks ( Internal & external )
- Access time

**3.2.1** From the main menu, once the Auto I.D function is activated, the Module Type menu and the Clock Frequency menu will display allowing User to select the desired Data-Rate Frequency of 800 ,1066 or 1333 MHz to test the module. The tester will sense if the EEPROM has SPD data written, this menu selection will appear.

```
Select Data Rate :
[ 800 ] [ 1066 ] [ 1333 ]
```

**3.2.2** Once the 1066 MHz Data-rate frequency is selected, it takes about 3 –6 seconds to identify the SODIMM module depending on device type and configuration.

```
Identifying the Device ..... [ 00:03 ]
```

**3.2.3** If a known good module is detected, the SP3000 LCD will display the following parameters

```
DDR3 64Mx64 512MB 1B(8)@2x533Mhz 1.5V
[ Esc. ] [ Edit ] [      ] [ Defset ] [ Test ]
```

Press [ **Edit** ] key, bring up the **Edit Menu**.

Press [ **Test** ] key, bring up the **Test Menu**.

Press [ **Esc.** ] key, return to **Main Menu**.

Press [ **-Defset** ] key, to reset all test pattern to factory default value [ Walk Data, Walk address, Mat-S ]

**3.2.4** If a defective/bad module is detected, an error message will be prompted:  
Occasionally this can be due to bad contacts of modules with the test sockets. If this happens, remove and re-insert the DIMM module firmly and press the [ **Auto ID** ] to retest again. EDO/FPM standard DRAM or SDRAM module will not fit into the DDR3 Adapter the "Cannot Identify Device" will be prompted as shown below.

```

Cannot Identify Device.
[ Esc. ][           ][           ][ Auto ID ]

```

### 3.3 File Menu

For verifying a *known memory module*, the following menu should be selected. The following display contains only 2 standard device with predefined - **BASIC** test. The SP3000 tester allows up to a limited 8 customized test parameters to be saved. For more storage device file selection, the SP3000 Advanced PC software offers more device selection. Please check with CST customer support for a copy of the PC software.

```

Std. Dev. - 2, User Saved Dev. - 0
[ Esc. ][ Std. ][ User ][           ][           ]

```

After [ **Std.** ] or [ **User** ] key is pressed:

```

1>DDR3 128M x 64 1024MB 2B(8) @ 2x533Mz
[ Esc. ][ Edit ][           ][ Next ][ Test ]

```

For [ **Edit** ] function, refer to section **3.4 Edit Menu.**

Press [ **Next** ] function scroll to **Next** device file.

For [ **Test** ] function refer to section **3.4 Test Menu.**

Press [ **Esc.** ] key return to **Main Men**

### 3.4 Edit Menu

This menu allows users to modify the test parameters and test patterns.  
There are two buttons that are use throughout the Edit Menu:

[**Scroll**] - the extreme right button, allows for page scroll to next screen which show more parameters.

[ **Esc.** ] - the left button, when depressed returns back to previous menu

**Edit Menu 1:**

```

DDR3 128Mx64 1024MB 1B(8) @ 2x533Mz
[ Esc. ][ AdrDat ][ BnkCtl ][ Pattn ][Scroll ]

```

[AdrDat] - to edit **Address/Data Parameters**

[BnkCtl] - to edit **Bank Control Parameters**

[ Pattn ] - to edit **Test Pattern/Preheat /Loop Parameters**

**Edit Menu 2:**



DDR3 128Mx64 1024MB 1B(8) @ 2x533Mz  
[ Esc. ] [ Volt ] [ Timing ] [ SPD ] [ Scroll ]

[ Volt ] - to edit **V.d.d. and Bouncing**

[Timing ] - to edit **CIK Frequency ,Refresh & Delays Parameters**

[ SPD ] - to edit **SPD setting**

**Edit Menu 3:**



DDR3 128Mx64 1024MB 1B(8) @ 2x 533 Mz  
[ Esc. ] [ F-Name ] [ P-Heat ] [ Type ] [ Scroll ]

[F-Name] - **Set File Name.**

[P-Heat ] - **Pre Heat**

[ Type ] - **Select or Disable Registered Module**

**Edit Menu 4**

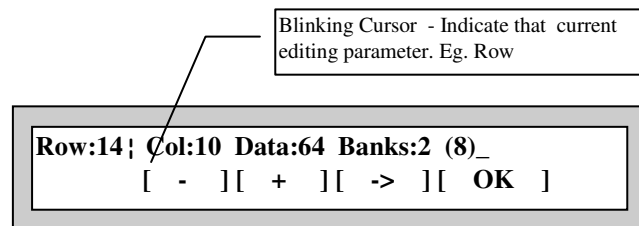


DDR3 128Mx64 1024MB 1B (8) @ 2x533Mz  
[ Esc. ] [ ] [ ] [ S.O. E ] [ Scroll ]

[ S.O.E ] - **Stop on first Error**

### 3.4.1 [ Addr Data ] Address/Data Sub-Menu.

This menu allowed users to redefine the parameters on:



- Address Setting - Number of Rows, Number of Columns, Number of Banks.
- Number of Data Bits
  - [ - ] - Hold down and decrement the current parameter by 1.
  - [ + ] - Hold down and increment the current parameter by 1
  - [ -> ] - Point to next parameter.

When the cursor is at *Bank item*, continuous pressing will bring the cursor back to the *Row Item*

**Note :**

- The program will perform range checking on the current parameter.
- If the value is below the range, it will roll to the higher value.
- If the value exceeds the range, it will roll to the lowest value.
- For 'Row' and 'Col.', Range is between 8 and 16.
- For 'Data', Range is between 1 and 72.
- For 'Banks', Range is between 1 and 4.
- All DDR3 Chip has 8 internal banks

**3.4.2 [ Bank Ctl ]Bank Control Sub-Menu.**

- ◆ This menu enables changes for the RAS and CAS control signals of each bank
- ◆ The program will first display the RAS Control Menu , then followed by the CAS Control Menu.
- ◆ If the module has more than 1 bank, the program repeatedly shows the RAS Control and CAS Control Menus until last bank has been modified.
- ◆ When a CS is enabled, the LCD Display will show a [ \_ ] enclosing the number; otherwise, it is disabled.

**CS Control Menu:**

Bank No. : Total Number of Banks

S: [ 0 ] 1 2 3 Bank: 1  
[ Esc ] [ Toggle ] [ <---- ] [ ---> ] [ OK ]

**[Toggle]** - Enable or Disable the current Chip select setting. [ x ] indicates enable.

[ -> ] - Rotate the *underlined cursor* to next CS selection.

[ OK ] - complete the changes.

**CKE Control Menu:**

CKE: [ 0 ] 1 Bank: 1  
[ Esc ] [ Toggle ] [ <--- ] [ ----> ] [ OK ]

**[Toggle]** - Enable or Disable the current CKE setting.

[ -> ] - Rotate the *underlined cursor* to next CKE .

[ OK ] - complete the changes.

**DQS – Data Strobe Control Menu:**

DQM : [ 0 ] [1] [2] [3] [4] [5] [6] [7] [ 8] Bank:1  
[ Esc ] [ Toggle ] [ <---- ] [ ----> ] [ OK ]

[Toggle] - Enable or Disable the current DQS setting.

[ -> ] - Rotate the *underlined cursor* to next DQS.

[ OK ] - complete the changes.

#### **DQM Control Menu: (Data Mask Enable)**

Module with DM 0-8 controls

[Toggle ][ OK ]

DM : [ 0 ][ 1 ][ 2 ][ 3 ][ 4 ][ 5 ][ 6 ][ 7 ][ 8] Bk:1

[ Esc ][ Toggle ][ <---- ][ ----> ][ OK ]

#### **3.4.3 SPD . Sub-Menu.**

The **Serial Present Detect (S.P.D.)** is used by DIMM Memory manufacturer to indicate the configuration, speed and some other specifications. It is done so by selectively programming the serial EEPROM on the DIMM modules.

000 : 80 08 08 0E 0A 50 40 07 08 09 0A 0B

[ Scroll ][ Saved ][ Config ][ Read ][ OK ]

[ Saved ] - Accept the read SPD information and save to Tester Buffer

[ Config ] - Change SPD parameters.

[ Read ] - Read SPD data from module's EEPROM inserted on the DUT.

[ O.K. ] - Accept the changes made in this menu and return to previous menu.

[ Scroll ] - Go to next page of SPD setting menu

000 : 00 01 02 03 04 05 06 07 08 09 0A 0B

[ Scroll ][ W->DUT ][ Edit ][ ] [ Ok ]

[ W->DUT ] - Write SPD Data from into SPD EEPROM into Device Under Test

[ Edit ] - Edit SPD data – enable user to scroll byte by byte to edit SPD data

000 : 00 01 02 03 04 05 06 07 08 09 0A 0B

[ Scroll ][ Prnt ][ ] [ SetSWP ][ ClrSWP ]

B 000 : Number of Bytes Written 80 h

[ OK ][ >> ][ Toggle ][ Back ][ Next ]

[ >> ] - Double arrow enables user select which two hex digit to edit

[ Toggle ] - Toggle enable user to set Hex number

[ Back ][ Next ] - Back & Next key - to scroll forward or backwards to select byte

```

000 : 00 01 02 03 04 05 06 07 08 09 0A 0B
[ Scroll ] [ Prnt ]

```

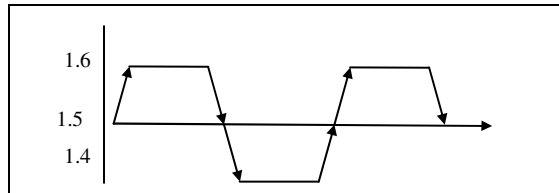
[ **Prnt** ] - sent to Print SPD content from the tester buffer

#### 3.4.4 [ Volt ] D.C. Voltage Parameters Sub-Menu.

When testing any module an upper or lower voltage limits are necessary. The **VCC**. voltage setting in this menu allows user to perform this task.

3 test voltages are selectable:

- For 1.5V Module, Voltage adjustable are 1.4V, 1.5V and 1.6V  
The software **Bouncing** option when enable, permits voltage cycling  
eg. for 1.6 V device



[ **Vcc** ] - 3 Voltage settings for selection. 1.4V -> 1.5V -> 1.6V

```

Vcc : 1.5 V Bounce - No
          [ Vdd. ][Bounce][ OK ]

```

[ **Bounce** ] - Voltage Bouncing **Yes** or **No**.

#### 3.4.5 [ Timing ] Clk Frequency /Refresh Parameters Sub-Menu.

```

CLK : 400 Mhz
[ Clk Frq ] [ MR0 ][ MR1 ][ MR2 ][ OK ]

```

```

Clock Frequency (MHZ) : 400
[ ESC ][ ← ][ → ][ OK ]

```

- **Clock Frequency** can be preset from 400 ~ 670 MHz in steps of 5Mhz
- [ **MR0** ] **Mode Register Set** for setting CAS Latency, Trcd, Trp & Write Latency
- [ **MR1** ] **Extended Mode Register Set** for setting Output D.I.C, ODT resistor value.
- [ **MR2** ] **Extended Mode Register Set** for setting CAS Write Length, Refresh rate, MPR, Disable ODT)

### For MRS0 Setting ( Mode Register Set)

CL: 7 Wr:7 Trcd : 7 Trp : 7  
[ CasLat ] [ WR ] [ Trcd ] [ Trp ] [ OK ]

Most DDR3 1066Mhz DIMM are preset with (CL=7, WR=7, T RCD=7 , TRP 7) setting. This setting is programmed into the DIMM SPD.

- **CL Read** Latency can be preset to – 5,6 ( 800 ) 7,8 ( 1066Mhz) ,7,8,9 ( 1333Mhz)
- **WR** : Write Recovery Precharge can be change from 5, 6,7,8. Changing the WR setting does not affect test time
- **Trcd** is the time delay between the Row and column address – you can select either 5,6 ,7,8, 9 Clock
- **Trp** is the Auto Pre-charge time, DDR3 SDRAM internally generates the timing to satisfy Tras for the programmed burst length and CAS latency, you can select either 5,6,7,8, 9 Clock

### For MRS1 Setting ( Extended Mode Register 1 Set)

ODT : 40 ohm Output DIC : 34 ohm  
[       ] [       ] [ ODT ] [ D.I.C ] [ OK ]

The MRS1 setting offer in the SP3000 DDR3 tester, are for advanced users. Always used the default value.

- **ODT** : stands for **On-Die-Termination** , is a feature that allows a DRAM to turn on/off termination resistance for each DQ,DQS,RDQS and DM Signal via the ODT control. The ODT feature is designed to improve signal integrity of the memory channel by allowing the DRAM controller to independently turn on/off termination resistance for any or all dram devices. In the SP3000, user can select 20,30,40, 60ohm or 120ohm or disable the termination resistor
- **[ Output D.I.C ]** – Driver Impedance Control.. user can select 34,40 ohm

### For MRS2 Setting ( Extended Mode Register 1 Set)

DODT: Off CAS\_WL:5 Refresh  
[ DODT ] [Cas\_WL] [ Refresh ] [ OK ]

[ **DODT** ] – Dynamic ODT Control.. user can select off ,60,120 ohm

[ **CAS\_WL** ] – Write Latency user can select off 5,6,7 and 8 Clock

[ **Refresh** ] - Change the type of refresh

2 types of Refresh are used - **no refresh & CAS before RAS (CBR)**



Refresh Periods can be preset to - **8, 16, 32, 64 or 128** us per row.

- **None** (No) Refresh
- **CBR** (C.A.S. Before R.A.S.) Refresh
- [ **Period** ] - Change the Refresh Period. Period (us/row) - 8, 16, 32, 64, 128

### 3.4.6 [ **Pattn** ] **Test Pattern/Preheat/Loop Parameters Sub-Menu.**

The **SP3000** utilizes the fast testing time approach to uncover any assembly errors and memory cell failures.  
They are built with very fast tests time for high throughput and will provide over 99.5% confidence level on accuracy.

The user friendly selectable tests options are:

- Walk Data test [ w\_data ]
- Walk Address test [ w\_addr ]
- Mat + S [ Marching ]
- March\_C
- March\_X
- March-Y
- Moving Inversion
- Chip Select Test [ c.s. ]
- CKE Test [ CKE ]
- DQM Test [ DQM ]
- S.P.D. Data Test. [ SPDDAT ]
- S.P.D. Address Test [ SPDADR ]

When the Test Pattern is activated, the following will be display:

<b>Test:adr+dat+mar+</b> [ Esc. ] [ Basic ] [ Custom ] [ Loop ]	<b>Page L001</b>
--	------------------

**[Basic]** - a quick key to switch to default patterns and default to 1 test loop.  
- default test pattern to w\_addr + w\_dat + mar+.

**[Custom]**- User selectable test pattern:

<div style="display: flex; justify-content: space-between;"> <span>[x]w_addr    [x]w_data    [x]Mat-S    [ ] Mat_X</span> </div> <div style="display: flex; justify-content: space-between;"> <span>[Toggle] [ &lt;- ] [ -&gt; ] [ OK ]</span> </div>
<div style="display: flex; justify-content: space-between;"> <span>[ ] Mar_C [ ]chk_CS [ ]chk_CKE [ ]chk_DQM</span> </div> <div style="display: flex; justify-content: space-between;"> <span>[Toggle] [ &lt;- ] [ -&gt; ] [ OK ]</span> </div>
<div style="display: flex; justify-content: space-between;"> <span>[ ] spdRC [ ]spaddr</span> </div> <div style="display: flex; justify-content: space-between;"> <span>[Toggle] [ &lt;- ] [ -&gt; ] [ OK ]</span> </div>

- [Toggle]** - Toggle the check-box '[x]' or '[ ]'
- [x] - enabled
  - [ ] - disabled
- [ OK ]** - Move the cursor to next menu item
- [ Loop ]** - Test Loop Configuration:  
Range between 1 and 999.

```

Test Loop : 001
[ Esc ][ Toggle ][ <-- ][ --> ][ OK ]

```

[ <-- ]- Toggle key and increment by 1

[ --> ]- Toggle key and increment by 1.

Setting Test Loop to : 000 will set the tester into a continuous burn-in loop.

#### 3.4.7 Set File Name Menu

Allow the user to alter the name of the file:  
Range of Characters - '0' to '9' and 'A' to 'Z'

```

File Name : DEMO____
          [ - ][ + ][ -> ][ OK ]

```

[ + ] - Hold down and increment the character.

[ -> ] - Rotate the *underline* cursor to next position.

#### 3.4.8 Stop-On-Error Menu

Default is **STOP\_ON\_ERROR** enabled, so that during testing, first error encounter will stop the test immediately and print the result.

### 3.5 Test Menu

This menu is assigned as the Auto-ID or File Menu. When the user presses the [ **Test** ] Key, The **SP3000** will perform an ICC current measurement check before starting test and the display message will be as follows.

```

L001: ICC Current          [ 00:01 ]
[Cancel]

```

|--Elapsed Time--|

```

L001: Walk Address        [00:05]
[ Cancel ]

```

If no modules are present on the SP3000 Test socket , the tester will prompt an failure message on the display screen and it is as follows.

```

** Fail : wk_addr @ 2x 533Mhz , L1 ** [00:01]
[ Esc ][      ][      ][      ][ Test ]

```

During the testing, any errors detected during testing will be aborted immediately and the **FAIL** message will be displayed. Otherwise if no errors are detected, upon completion of the defined tests, a **PASS** message will be displayed.

### 3.6 Result Menu

After completing all the defined tests with no errors detected, the LCD will display as follow:

```
** PASS ** @ 2x533 Mhz L001 *    [ 00:08 ]  
[ Esc.  ] [ Result ] [ Print ] [ View ] [ Test ]
```

[ **Print** ] - Print Pass Results.

[ **Test** ] - Test Function.

[ **Esc.** ] - Return Previous Menu

If an error is detected, the tester will display the following message:

```
** FAIL - Walk_Data, L1 **      [ 00:08 ]  
[ Esc.  ] [ Result ] [ Print ] [ View ] [ Test ]
```

[**Print**] - Print Error Results.

[ **View** ] - View the Error Details.

[ **Esc.** ] - Return Previous Menu.

#### 3.6.1 View Error Details

- A. When module “Failed” any test parameter, the following results will be displayed and view function is selected
- B. If the LCD cannot fully display all the failure bits on one screen or multiple banks have errors, the
  - [ **More** ] key will appear for more data to be displayed by pressing this key.

```
:1, 2, 3, 4, 5, 6, 7, 8, 17-19, 35, 39, 49-51, 56-58, 68  
* Bank 1*                [ More ]
```

- The final screen display will indicate an [ **OK** ] key to show the last page. Pressing the key will return you to the previous menu.

### 3.6.2 Print Error Results

The **[Print]** function allows the user to output Error Results to the printer.  
A sample printout can be seen as follows:

```
○ CST Inc  SP3000  DDR3 – 1333 Mhz  Rev x 3.03x  ○
○ ~~~~~  ○
○ Module : DDR3 128Mx64 1GB 1B (8) 2x533mhz 1.5V  ○
○ Addr. ( row x col. ) : 14 x 10  ○
○ Data (bank x bit) : 1 x 64  ○
○ Internal Bank : 8  ○
○ Test Pattern : w_addr, w_data, mt-s,  ○
○ Loop # : 1  ○
○ ## FAIL : Walk Data - Loop 1 ##  ○
○ Bank 1 : 1, 3, 5, 7, 9, 11, 13, 15, 17, 19, 21, 23, 27, 29, 31-32  ○
○ Elapsed Time : 00:00:04  ○
○  ○
```

### 3.6.3 Check Result

This menu allows user to check back which test has passed or failed.

```
Pass: dat, adr
Fail: mat+ [ OK ]
```

## 3.7 File Save/Delete Menu

### 3.7.1 Save File

After Auto-Identifying a new device and pressing **[ ESC ]** to return to the main menu , or Editing an existing device and pressing **[ ESC ]** to return to the main menu.. The tester will prompt you to the following message:

```
Do you want to save this file?
[ F-Name ] [ No ] [ Yes ]
```

**[F-Name]** - Place a 8-char. file name for further reference.

You can also access from Edit-Menu 3.

**[ Yes ]** - Save file.

Maximum 8 files allowable to be saved, if files exceeds then the following prompt will appear, It you press [Yes]

```
Files Full !!! Delete old files ?
[ No ] [ Yes ]
```

**[ No ]** - Abort Saving.

### 3.7.2 Delete File

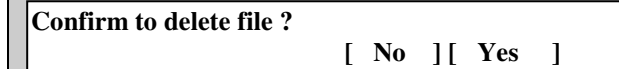
This menu is accessible from the user saved file menu - Option [ **Del.** ]  
When Auto-ID a new device and pressing [ **ESC** ] to save the device and the maximum device is exceeded, then the tester will automatically prompt you the following menu:



5>DDR3 128Mx64 1GB 1B(4) @2x533Mhz #1.5V  
[ **Done** ] [ **Delete** ] [ **Next** ]

[ **Done** ] - exit the delete menu.

[ **Delete** ] - Delete the current selected file.



Confirm to delete file ?  
[ **No** ] [ **Yes** ]

[ **No** ] - Abort Delete

[ **Yes** ] - Confirm Delete

[ **Next** ] - Advance to next file.

## 4. Quick Testing Guide with Examples

This chapter will guide you through a simple example with a known DDR3 DIMM module to help you get familiar with the **SP3000 DDR3** functions. If you should have any doubt on the menu options, please refer back to the previous chapter on operations basics for a detailed explanation.

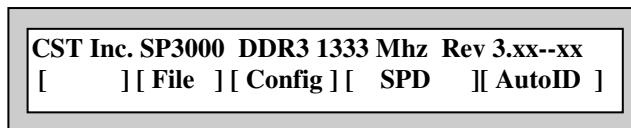
The examples illustrated in this section use a standard **240pin 128Mb x 64 DDR3 DIMM** memory module. The device attributes are as follows:

- Voltage. :1.5V
- Row x Col. :14x 10 ( 1 bank)
- Data Bit x External Bank x Internal Bank : 64 x 1 ( 8 )

### 4.1 Auto ID an Unknown Device (No SPD Programming)

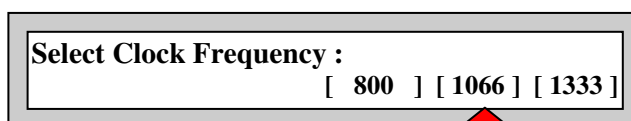
Assume device type is unknown (in this example, 128Mx64 is used), an **Auto-ID** function is carried out to determine the memory device attribute. The **BASIC** test is performed to determine if the module is good or bad. So let's run through the steps:

**Step 1:** Insert the unknown DDR3 DIMM device into the test socket. The main menu screen will display as follows:

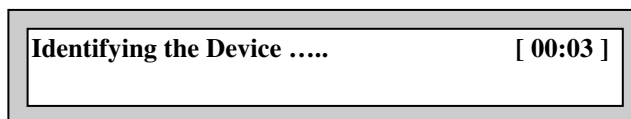


**Step 2:** Select [ **Auto-ID** ] and you will be prompted the following menu

Make your selection according to Data-rate required to test the module at [ select 400 , 533 & 667 Mhz if you are unsure ] :



Wait for a few seconds,



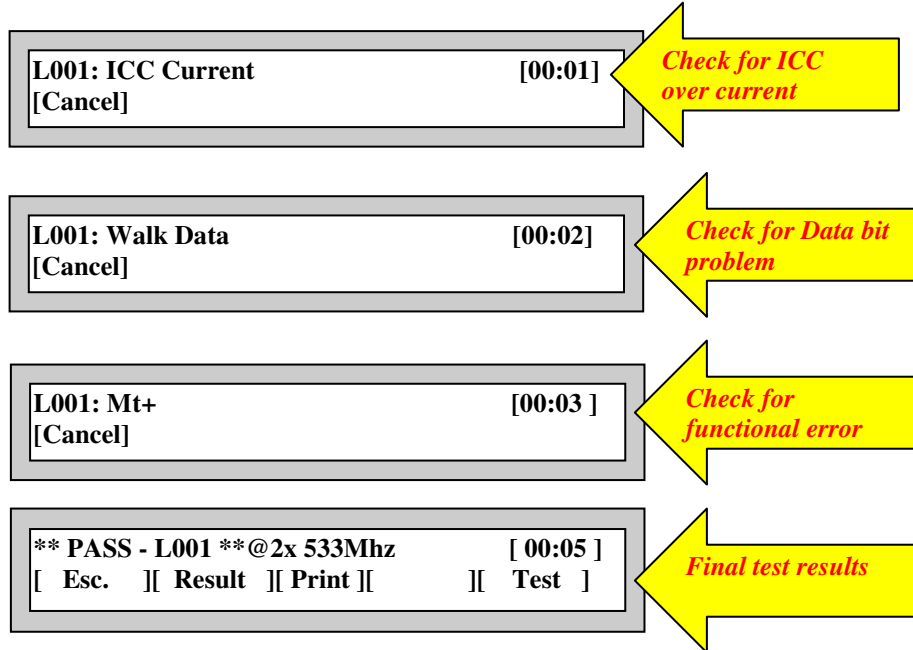
**Step 3:** Compare the device attributes shown on the LCD Display with your known device attributes. 1GB DDR3 DIMM @ 1066Mhz



**Indication of Device are as follows :**

- ◆ DDR3 : Double-Data-rate DIMM
- ◆ 128Mx64: Address base x Data Bit configuration of module
- ◆ 1GB : Memory Size
- ◆ 1B : External Bank ..... eg One external bank
- ◆ ( 8 ) : Internal Bank .....eg Eight internal bank
- ◆ Vdd : Vdd voltage .....eg 1.5V

Step 4: Press **[ Test ]** to perform the **BASIC** Test.



Step 5: Press **[Result]** to view the individual pass/fail test result.

Step 6 : Press **[ Print ]** to print a copy of the individual test result

Step 6 : Press **[Esc]** **twice** to return to the main menu.  
Before reaching the main menu, the tester will prompt you to save the new device detected.

**Do you want to save this file?**

[ Cancel ] [ F-Name ][ No ][ Yes ]

Step 7 : Press **[ No]** and return to main menu.

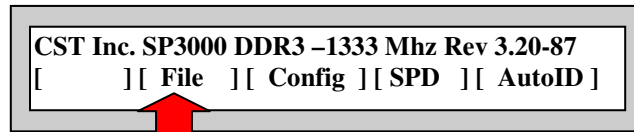
Step 8 : End of example.

## 4.2 Testing a Known Device with Stored File ( No Programming SPD)

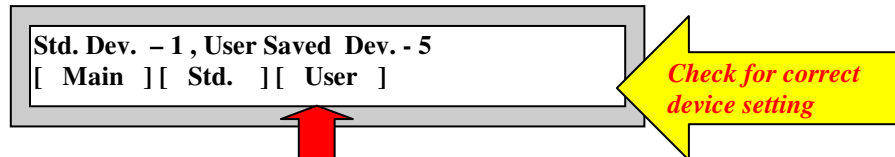
To perform a test on a known standard device:

*Step 1* : Insert the known device in the test socket.

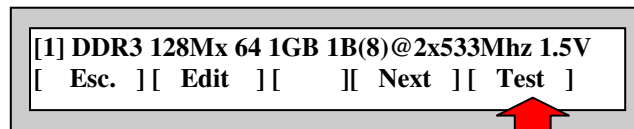
*Step 2* : Select **[ File ]** Menu.



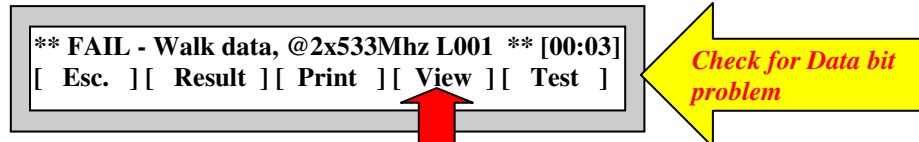
*Step 3* : A next menu will prompt you to select **[ Std ]** Device or **[ User Saved ]** Device



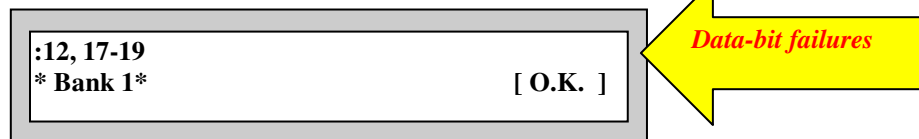
*Step 4* : Choose **[ User ]** for the standard device file.  
Use **[ Next ]** to scroll to the next Device.



*Step 5* : Press **[ Test ]** to start the testing.  
If module under test fails, the LCD will display :



*Step 6* : Press **[ View ]** to see the error in detail.  
Press **[ OK ]** to return previous LCD display.



**Results indicates Module Fail Bank 1 , Data-bit DB12, DB17-19.**

*Step 7* : If a printer is connected, press **[ Print ]** to print the error results.

*Step 8* : Press **[ Esc ]** twice to the main menu.

*Step 9* : End of example.



### 4.3 Changing Test Parameters

Whenever the [ **Auto ID** ] or [ **File** ] options is selected,  
The Test Parameters can be changed by selecting the [ **Edit** ] key.

This section illustrates how to activate the **MAT-S** test, and change the Operating Voltage  
- **Vdd** to either 1.4V - 1.5V - 1.6V, and activate **Chk\_CS** and **Chk\_DQM** test

**Step 1 :** Select [ **File** ] Menu, then  
          [ **Std** ] to standard device.  
Use      [ **Next** ] Key to scroll to DDR3 128Mx64 device.  
Press    [ **Edit** ] to edit the device

```
1>DDR3 128Mx64 1GB1b(8)@2x533Mhz 1.5V
[ Esc. ] [ Edit ] [      ] [ Next ] [ Test ]
```

**Step 2 :** Press [ **Edit** ] for more parameter options.

```
1>DDR3 128Mx64 1GB 1B(8)@2x533Mhz 1.5V
[ Esc. ] [ AdrDat ] [ BnkCtl ] [ Pattn. ] [ Scroll ]
```

**Step 3 :** Press [ **Scroll** ] for more parameter options

```
1>DDR3 128Mx64 1GB 1B(8) @2x533Mhz 1.5V
[ Esc. ] [ Volt ] [ Timing ] [ SPD. ] [ Scroll ]
```

```
1>DDR3 128Mx64 1 GB 1B(8)@2x 533Mhz 1.5V
[ Esc. ] [ F-Name ] [ P-Heat ] [ Type ] [ Scroll ]
```

**Step 4 :** Choose [ **Volt** ] to edit VDD

```
Vdd : 1.5V Bounce - No
      [ Vdd ] [ Bounce ] [ OK ]
```

**Step 5 :** Toggle [ **Vcc** ] until 1.6V is displayed, press [ **OK** ] to return to previous menu

```
1>DDR3 128Mx64 1GB 1B(8) @2x533Mhz 1.6V
[ Esc. ] [ Volt ] [ Timing ] [ Pattn ] [ Scroll ]
```

**Step 6 :** Select [ **Pattn** ], to enter into the **Test Pattern** Menu,

```
Test: adr+dat+mt+                               | PageL001
[ Esc. ] [ Basic ] [ Custom ] [                ] [ Loop ]
```

Step 7 : You can either choose to change the pattern from the [ **Basic** ] function (for quick setup) or from the [ **Custom** ] function (for detail setup).

Select [ **Basic** ] to view test pattern setup,  
Press [ **Mat+** ] toggles between [ **+March** ] or [ **Basic** ]

```
Test :wD+wA
[ Esc ] [ +Mat ] [ Custom ] [      ] [ Loop ]
```

Step 8 : Select [ **Custom** ] to customize the test pattern.

```
Test:adr+dat+mt                                L001
[ Esc. ] [ Basic ] [ Custom ] [      ] [ Loop ]
```

Step 9 : Use [ **->** ] [ **<-** ] key to scroll cursor to [ **]Mt+**  
press [ **Toggle** ] to active test. The [ **x** ]Mt= will appear marked to indicate

```
[x]w_addr   [x]w_data   [x]mt [ ] Mar_X
          [ Toggle ] [ <- ] [ -> ] [ OK ]
```

Step 10 : press [ **->** ] [ **<-** ] key to scroll menu to [ **]CS\_test**, and  
press [ **Toggle** ] to activate test.  
The [ **x** ]CS\_test will be marked to indicate test selected

```
[ ] Mar_C [X] chk_c.s [ X ] chk_dqm
          [ Toggle ] [ <- ] [ -> ] [ OK ]
```

press [ **->** ] [ **<-** ] until cursor moves to the end of menu

```
[ ] spd_Rc [ ] spdaddr
          [ Toggle ] [ <- ] [ -> ] [ OK ]
```

Press [ **Done** ] to return to previous menu.

```
Test : adr + dat +mt+                                | PageL001
[ Esc. ] [ Basic ] [ Custom ] [ Loop ]
```

**Step 11 :** Press the **[Esc]** key until a save file menu appear.

<b>Do you want to save this file?</b> [ F-Name ] [ No ] [ Yes ]
--

**Step 12 :** Select **[F-Name]** to edit filename.  
Use **[ + ]** or **[ - ]** keys to change the character and  
**[ -> ]** to move to next character position.  
press **[OK]** when done.

<b>File Name : DEMO</b> ____ [ - ] [ + ] [ -> ] [ OK ]
---

<b>Do you want to save this file?</b> [F-Name] [ No ] [ Yes ]
--

Press **[Yes]** to save.

**Step 13 :** The Used Saved Dev. updated from 0 to 1.

<b>Std. Dev. - 1, User Saved Dev. - 1</b> [ Esc. ] [ Std. ] [ User ] [ ]
---

**Step 14 :** This ends the example

## 4.4 Test a Device and Program SPD ~ All in One Key Punch Function

Assume device needs to be **tested** for **functions** and also be programmed with the **SPD** content. To continue, find a sample module with the correct SPD content that you intend to duplicate the information to other modules to be tested and programmed, and set the tester configuration as follows :

**Step 1:** Insert a good DDR3 DIMM with known good SPD content into the test socket. From the menu screen, select the SPD function and this will prompt the following screen

CST Inc. SP3000 DDR3 1333 Mhz Rev 3.20-f6  
[     ] [ File ] [ Config ] [ SPD ] [ AutoID ]

*All Settings selected under [Config] is retained even when the tester is powered down. If user wished to change certain default settings, go into [Config] Menu to edit again.*

**Step 2:** Select [ **Config** ] will prompt the System Configurations sub menu.  
System Configuration Sub-Menu #1

System Configurations  
[ Esc ] [     ] [ CrDev ] [ Default ] [ Scroll ]

System Configurations  
[ Esc ] [ Comm ] [ Print ] [ Handlr ] [ Scroll ]

**Step 3:** Select [ **Scroll** ] then [ **AutoID** ] will prompt the [ **Default Auto ID Setting** ] function

System Configuration Sub-Menu #2

Default AutoID Settings :  
[ Esc ] [     ] [     ] [ SPD ] [ Pattn ]

Select [ **Pattn** ] bring you to the Default Pattern setting. This setting will be retained even if you turn the power off the tester.  
Go through and activate the parameters that you want the module to be tested by.

- ◆ For **Open & Short** test, activate [ **x** ] **w\_data** , [ **x** ] **w\_addr**
- ◆ For Cell test on Chip, activate [ **x** ] **mt** , and/or
- ◆ For **SPD** test, the following must be activated - [ **x** ] **spdRC** , [ **x** ] **spdaddr**

[ x ] w\_data     [ x ] w\_addr     [ ] mt+  
[ Toggle ] [ <--- ] [ ----> ] [ OK ]

[ ] c.s [ ] dqm [ x ] spdRC     [ x ] spdaddr  
[ Toggle ] [ <--- ] [ ----> ] [ OK ]

Select [ **OK** ] to go back to System Configurations sub-menu 2  
System Configuration Sub-Menu #2

**Default AutoID Settings :**

[ Esc ] [            ] [            ] [ **SPD** ] [ **Pattn** ]

**Step 4:** Select [ **SPD** ] to go to the SPD default configuration menu. Setting in this menu will be retained even upon power down of tester.

- The [ Write Page Length ] is set according to EEPROM specifications
- The [ SPD Read ] [SPD Write ] specify the read and write range.
- [ Mask out Byte 120-125 ] - these locations are used for programming manufacturing serial number and date code information.

**WRT Page Length = 4 :**

[ Esc ] [            ] [ <---- ] [ ----> ] [ **OK** ]

**SPD Read : 000 => 255**

[ Esc ] [ **Toggle** ] [ <----- ] [ -----> ] [ **OK** ]

**Mask Out Byte 120-125 ? : Yes**

[ Esc ] [            ] [            ] [ **No** ] [ **OK** ]

- The [ **Read Cmp** ] allow user to **Read & Compare** SPD data of the module under test with the SPD content that was saved in the buffer. No SPD rewrite is possible for this mode selection.
- ◆ The [ **Write Cmp** ] allow user to **Write & Compare** SPD data of that from the tester buffer to the module under test.
- ◆ **CRC Checksum is automatically calculated at Byte 126 - 127**

**SPD\_Data Test Allowed : RD\_Cmp**

[ Esc ] [            ] [ <---- ] [ ----> ] [ **OK** ]

**SPD\_Data Test Allowed : WR Cmp**

[ Esc ] [ **Toggle** ] [ <----- ] [ -----> ] [ **OK** ]



**Step 5:** Select [ **OK** ] and return back to the main menu

**CST Inc. SP3000 DDR3 1333Mhz Rev 3.20-f6**


[            ] [ **File** ] [ **Config** ] [ **SPD** ] [ **AutoID** ]



Select [ **SPD** ] [ **Read** ] and this will prompt the tester to read the SPD content from the module inserted in test socket

### SPD Sub-menu

000 : 00 01 02 03 04 05 06 07 08 09 0A 0B
[ Scroll ] [ Save ] [ Config ] [ Read ] [ OK ]



Select [ **Save** ] and this will prompt the tester to read the SPD content into the tester buffer.

**Note :** Only one set of SPD data can be saved at any time. By performing a save function, the previous saved file will be overwritten with the current set of saved data.

Once all the tester have been configured according as above, you are ready to Test and Program the SPD on each and every module under test (proceed to Step 6)

**Step 6:** Select [ **Auto ID** ] and the following menu will prompt for selection  
Make your auto-ID selection:

Select Data Rate :
[ 800 ] [ 1066 ] [ 1333 ]

DDR3 128Mx64 1GB 1b(8)@2x1066 Mhz 1.5V
[ Esc. ] [ Edit ] [     ] [ Next ] [ Test ]

**Step 7:** Select [ **Test** ] to test the module. If module is good and the SPD programming is successful, the following menu will be displayed.

** PASS - L001 ** @2x533 MH [ 00:05 ]
[ Main ] [ Result ] [ Print ] [     ] [ Test ]

**Step 8 :** Select [ **Result** ] to view the parameters that were active during this test

Pass : wD, wA, mt+, spdRc, spdaddr, [ 00.07 ]
Fail [ OK ]

**Step 9 :** Click [ **OK** ] and you can continue the test with another module.

**Step 10 :** This ends the example.

Setting Serial Number increment during SPD programming can only be executed using the SP3000 Advanced PC software. Refer to the SP3000- PC software user manual for details on how to enable the SPD serialization during SPD programming.

#### 4.5 How to set the SPD EEPROM “Permanent Write Protect” and “Reversible Write Protect”.

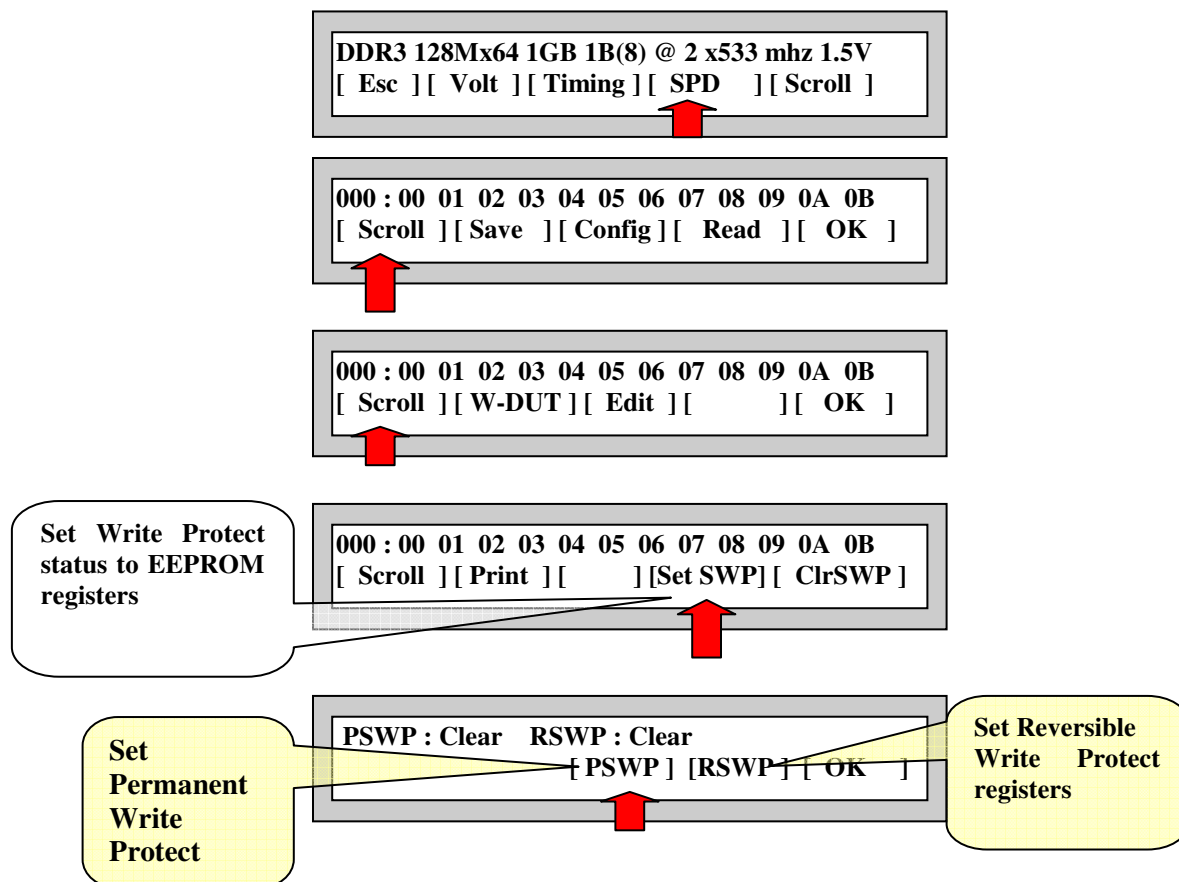
DDR3 SPD EEPROM uses a special function build in the EEPROM chip to enable manufacturer to set a “Permanent Software Write Protect” registers or “Reversible Software Write Protect” registers during SPD programming. Byte 0 to byte 255 of the SPD is protected by the PSWP and RSWP.

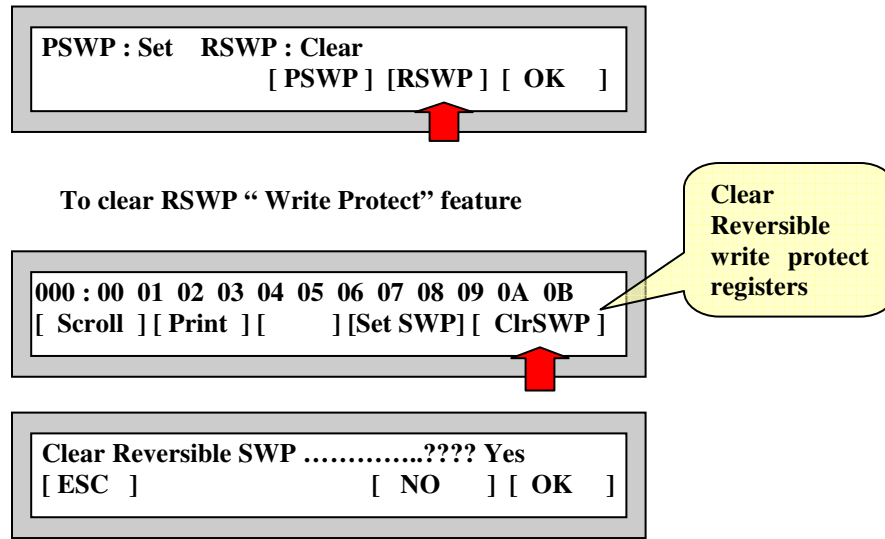
- Permanent Software Write Protect (PSWP), when enable during programming, the EEPROM cannot be rewritten again once the PSWP register is set. The software protection starts from Byte 0 – 255 of the SPD EEPROM
- Reversible Software Write Protect (RSWP), enable the EEPROM to be reset and rewritten again from Byte 0 – 255 many times.

##### Important Notes :

**The Permanent & Reversible Write Protect can be enable from the SP3000 tester. The selection to set/clear Permanent and Reversible is not available from the Advanced PC software. This is to prevent user from enabling the Write protect registers by accident.**

- On startup – insert module and identify the module.
- Ensure the current SPD data is saved on the tester
- Select [ Edit ] → [ Scroll ] → [ SPD ]
- Select [ Scroll ] → [ Scroll ] and the following menu will appear





Return to main screen and test module , the EEPROM will either be Permanent or Reversible write protect after programming

#### 4.6 How to decode a DDR3 Memory failure test results using the SP3000.

The SP3000 DDR3 tester is designed with an advanced “Fault-capturing” algorithm, capable of pinpointing the exact failure components. There are many kind of faults which could possibly surface during module assembly.

##### 4.61 For DDR3 Memory Standard Pin Description

- Address Pin ( A0- A12) open and short
- Bank Select Address ( BA0 – BA1) open and short
- Data Input/output ( DQ0 – DQ63) open and short
- Data Strobe Input/output ( DQS 0 – DQS 8) open and short
- Clock enable input ( CKE0, CKE1) open and short
- Chip select input ( CS0,CS1,CS2,CS3) open and short
- Row address Strobe ( RAS )open and short
- Column address Strobe ( CAS) open and short
- Write enable ( WE ) open and short
- On-Die-Termination ( ODT )
- Check Bit (ECC for 72 bit DIMM ~ CB0 – CB7) open and short
- Data Mask ( DM0-7)
- Power Supply (1.5V) VDD
- Power Supply for DQS ( 1.5V)
- Ground – VSS
- Power Supply Reference ( Vref)
- Serial EEPROM Power Supply ( 2.3V – 3.6V) VddSPD
- SPD Serial Data I/O ( SDA)
- SPD Serial Clock ( SCL)
- SPD Address in EEPROM ( SA0-2)
- No connection ( NC)



#### 4.62 SP3000 Error Message

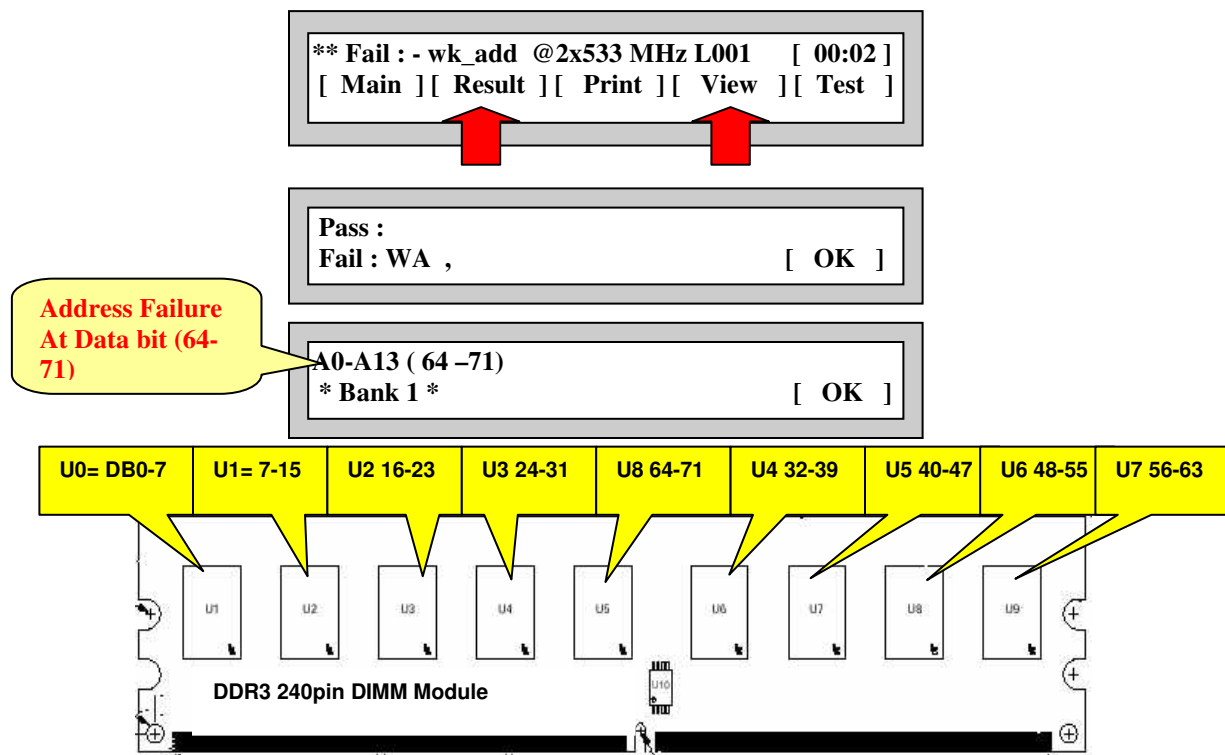
The following test pattern must be enable on the SP3000 tester in order to capture the following errors : Walk address, Walk data, Marching, Chk\_CS, Chk\_DQM, Chk\_DQS, Chk\_CKE, Chk\_ODT, SPD\_Address, SPD\_RC/WRC

- Address Pin ( A0- A12) open and short [ Walk Address failure ]
- Bank Select Address ( BA0 – BA1) open and short [ Walk Address failure ]
- Data Input/Output ( DQ0 – DQ63) open and short [ Walk Data failure ]
- Data Strobe ( DQS 0 – DQS 8) open and short [ Walk Data failure , DQS failure ]
- Clock enable input ( CKE0, CKE1) open and short [ Auto-ID half bank and CKE failure ]
- Chip select input ( CS0, CS1, CS2, CS3) open & short [ Walk Data failure and CS Failure ]
- Row address Strobe ( RAS )open and short [ Cannot Auto-ID & Walk Address failure ]
- Column address strobe ( CAS) open & short [ Cannot Auto-ID & Walk Address failure ]
- Write enable ( WE ) open and short [ All test fail ]
- On-Die-Termination ( ODT) [ ODT test fail ]
- Check Bit (ECC for 72 bit DIMM ~ CB0 – CB7) open and short [ Walk Data failure ]
- Data Mask ( DM0-7) [ DM test fail ]
- Power Supply (1.5V) Vdd [ Cannot Auto-ID, All test fail ]
- Power Supply for DQS ( 1.8V) [ Cannot Auto-ID, All test fail ]
- Ground – VSS [ All test fail ]
- Power Supply Reference ( Vref) [ Tester not capable of detect Vref fault]
- Serial EEPROM Power Supply ( 2.3V – 3.6V) Vdd SPD [ Unable to Read & Program SPD]
- SPD Serial Data I/O ( SDA) [ Unable to Read & Program SPD]
- SPD Serial Clock ( SCL) [ Unable to Read & Program SPD]
- SPD Address in EEPROM ( SA0-2) [ SPD Address failure]
- No connection ( NC) [ Tester not capable of detect NC fault]

**Example of common memory error capture by the SP3000**

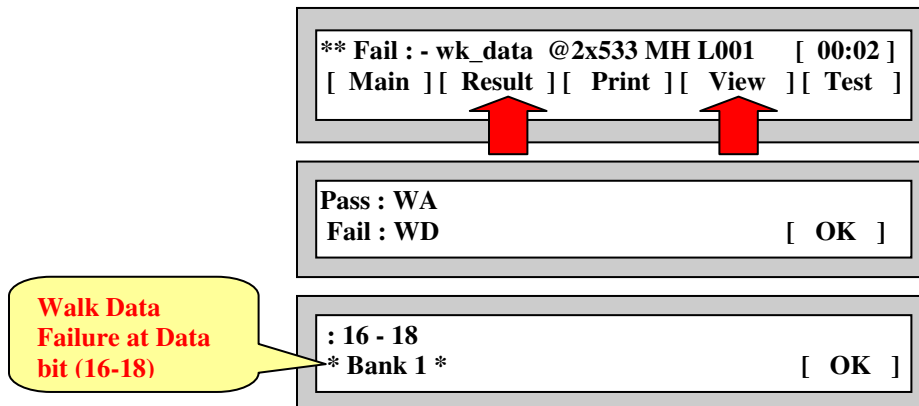
**Test Pattern selected on SP3000 : Walk Address, Walk Data and Mat-S Pattern**

**Walk Address failure** when ECC ( x72) bit are open , Data-Bit 64-71 will be detected as faulty.



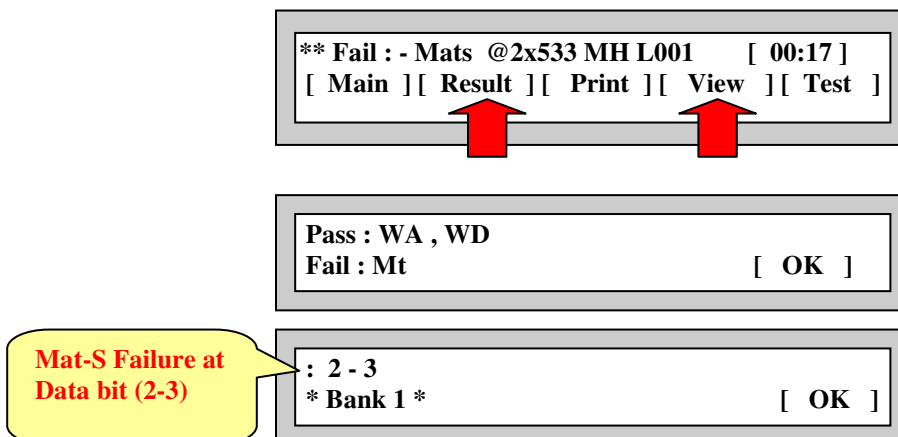
During RMA repair, the repair technician would usually removed the chip connected to (U8) DB 64-71 and replaced the faulty U9 chip with a known good chip. After rework , the module with the address failure will be retest to ensure module can pass all the test pattern.

**Walk Data failure** when Data Bit 16,17 & 18 are shorted



During RMA repair, the repair technician would usually removed the chip connected to (U2) DB 16-23 and replaced the faulty U3 chip with a known good chip. After rework, the module with the Data bit failure will be retest to ensure module can pass all the test pattern.

**Marching failure** when U1 has bad internal failures DB 2 & 3 , module failed when installed in the PC ( Symptoms : Blue screen )



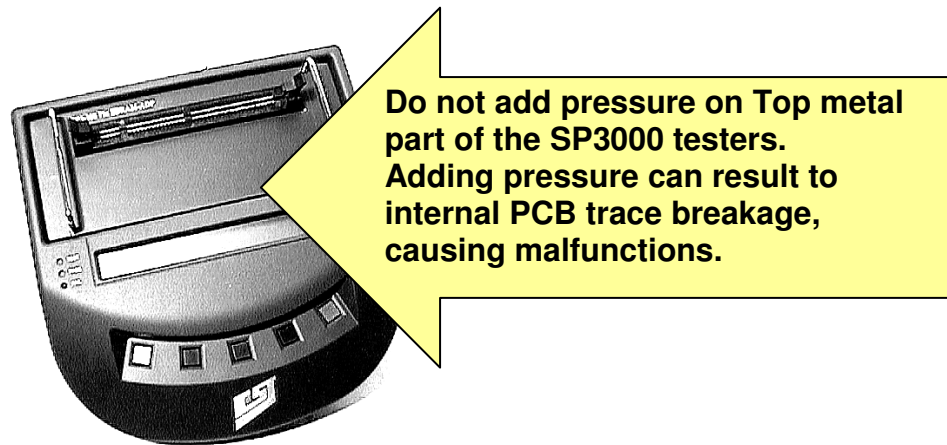
During RMA repair, the repair technician would usually removed the chip connected to (U0) DB 0-7 and replaced the faulty U1 chip with a known good chip. After rework, the module with the failure will be retest to ensure module can pass all the test pattern.

## **5.0 SP3000 - General Care & Trouble Shooting**

Protect the Sp3000 tester and Test adapters from adverse weather conditions. The memory tester are not waterproof and require gentle handling when operating Tester.

Do not press the metal part of the tester with heavy force, during insertions of memory module during production testing. Pressing against the metal part of the tester may cause the tester PCB to bow in the middle causing the electrical components to break.

Caution : to avoid damage to the Memory tester , do not expose it to sprays, liquids , or solvent.



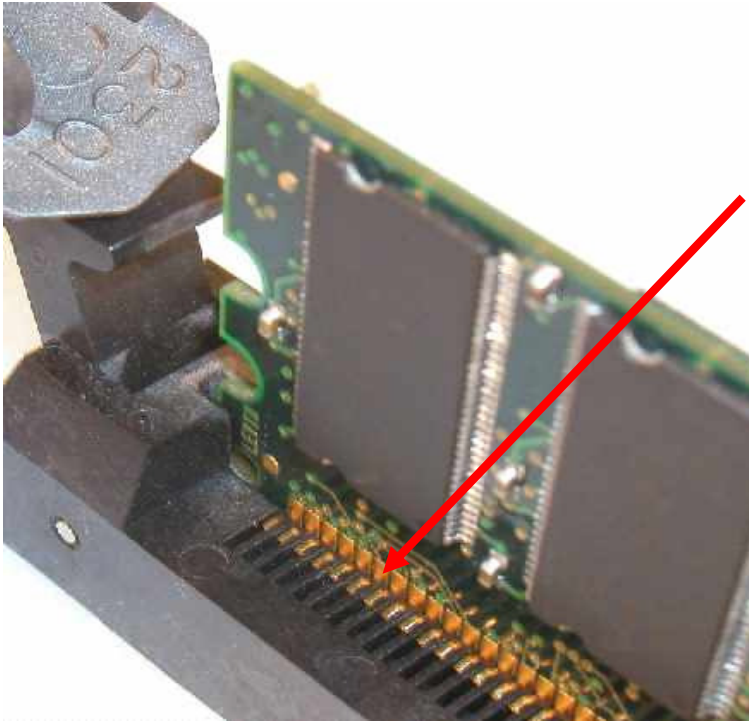
### **5.1 Cleaning**

Inspect the SP3000 Memory tester as often as operating conditions require. To clean the Memory tester exterior, perform the following steps:

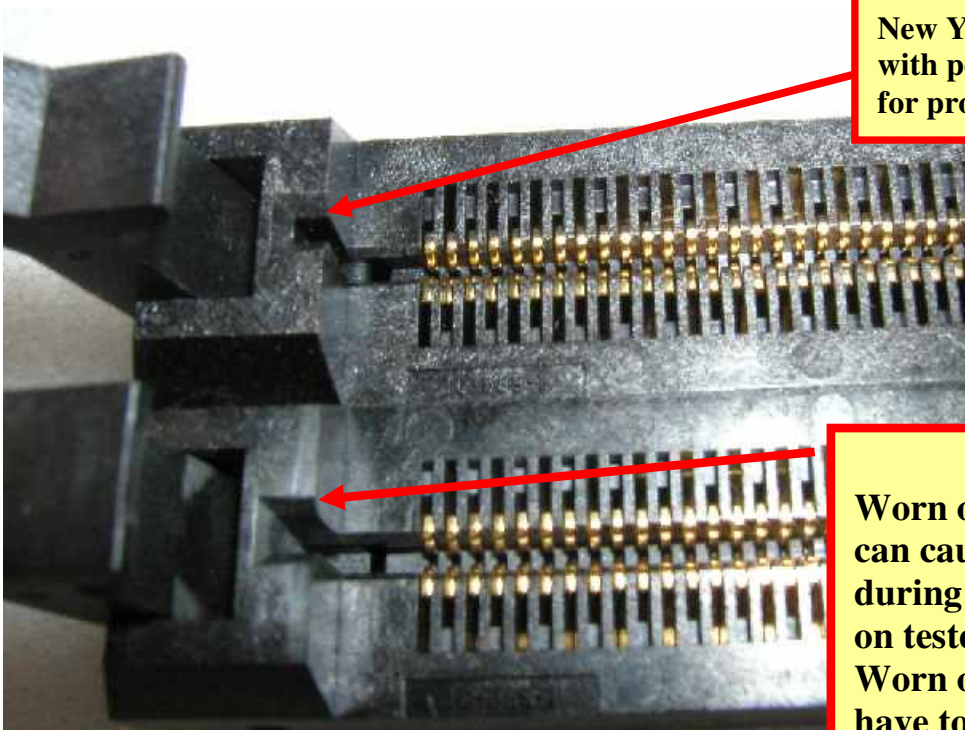
Remove loose dust on the outside of the Memory tester with a lint-free cloth. Use care and avoid scratching the clear LCD display.

Use a soft cloth or paper towel dampened with water to clean the memory tester. You can use 75% isopropyl alcohol solutions for cleaning.

The Yamaichi test socket requires regular cleaning, use “Electronic Contact cleaners” or Alcohol to clean the gold contacts only.



**Yamaichi test contact pins require, regular cleaning with electronic contact solvents. A clean contact will shine.**



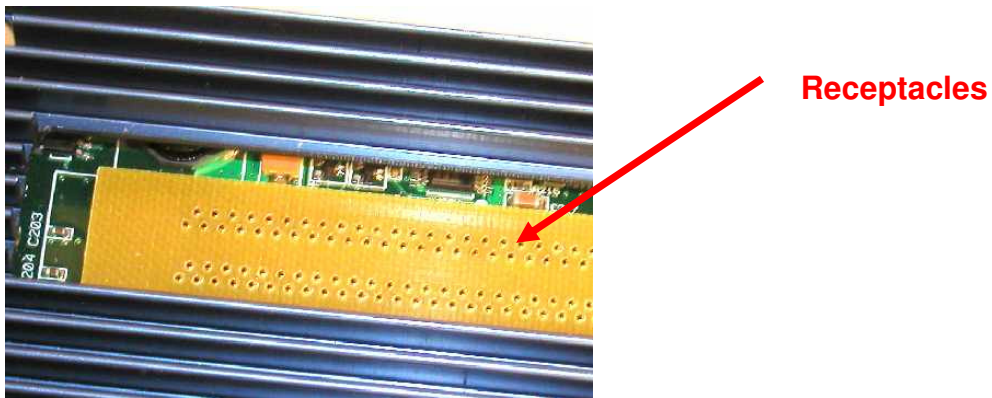
**New Yamaichi test socket with perfect socket guide for proper alignment**

**Worn out socket guides can caused misalignment during module insertions on tester.  
Worn out sockets will have to be replaced between 50K – 100K insertions**

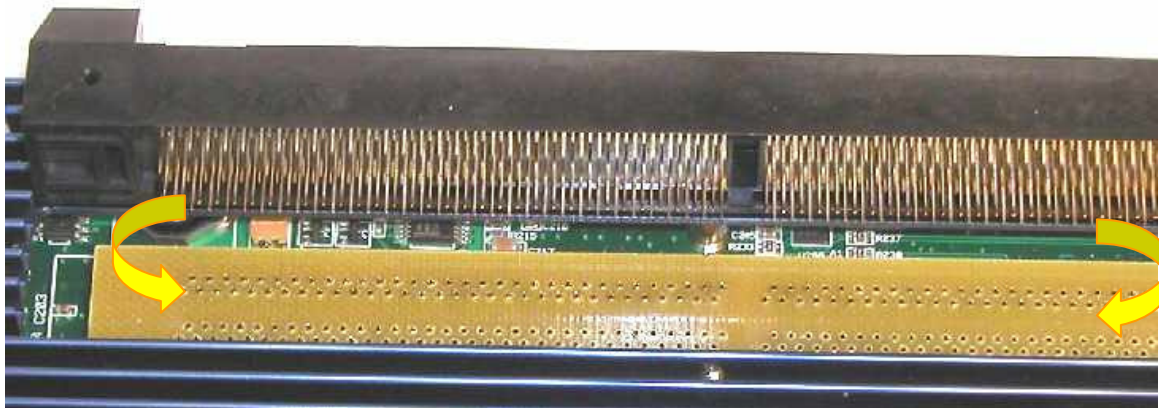
## 5.2 Replacing Worn out Test Sockets

Inspect the Test socket pins frequently, a broken test socket will not test module effectively and have to be replaced. Call CST for pricing for the different type of DIMM and SODIMM Test sockets.

CST Testers are designed with easy to replace test sockets. All CST SP3000 adapters are equipped with receptacle pins which enable the test socket to interface with the adapter without any soldering required. Aligned test socket pins over the receptacle pins, carefully and slowly push down the test sockets into the receptacles. Be very careful and do not break the test socket pins.



**240pin DDR2 Adapter with Test Sockets removed.**

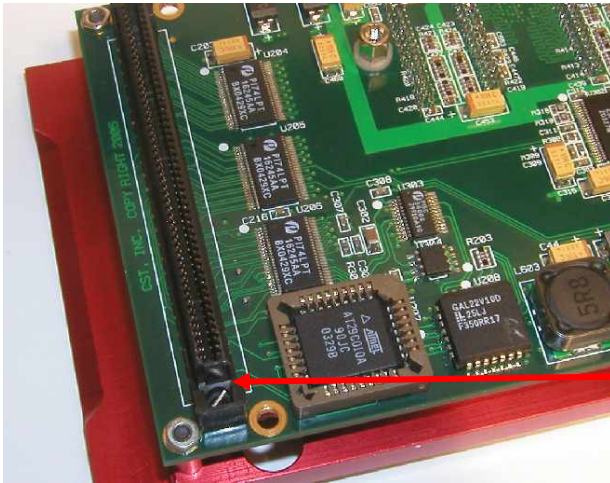


**240pin DDR2 Adapter with Test Socket ready for insertion**



### 5.3 General Troubleshooting Guide

The SP3000 memory tester is designed to last for many year, but certain parts of the memory tester are made of plastic and may might break if mishandled. On the bottom of the DDR/ DDR2/ DDR3 test adapter, a pair of 100pin female Robinson Nugent connectors breaks easily by the corners. Be very gentle when inserting the test adapter into the SP3000 base tester.



- Intermittent failures
- Tester unable to power up
- Unable to program SPD



Plastic corners breaks off ,  
if adapter is not inserted  
correctly

#### 5.3.1 SP3000 LCD Error Message

CST Inc. SP3000 DDR3 1333Mhz Rev 3.93-f6  
[     ][ File ][ Config ][ SPD   ][ AutoID ]

Good

CST Inc. Copyright 2008 All Rights Reserved  
SP3000 Initializing .....

Bad

**Corrective action :** Remove and insert SP3-Adapters firmly on the SP3000 base tester. Be sure to turn off power before removing adapter.

Blank Screen or Black Line across LCD

Bad

**Corrective action:** Remove adapter and check EEPROM on sockets located on the bottom of the adapter.

## 5.4 Upgrading the SP3000 DDR3 Firmware.

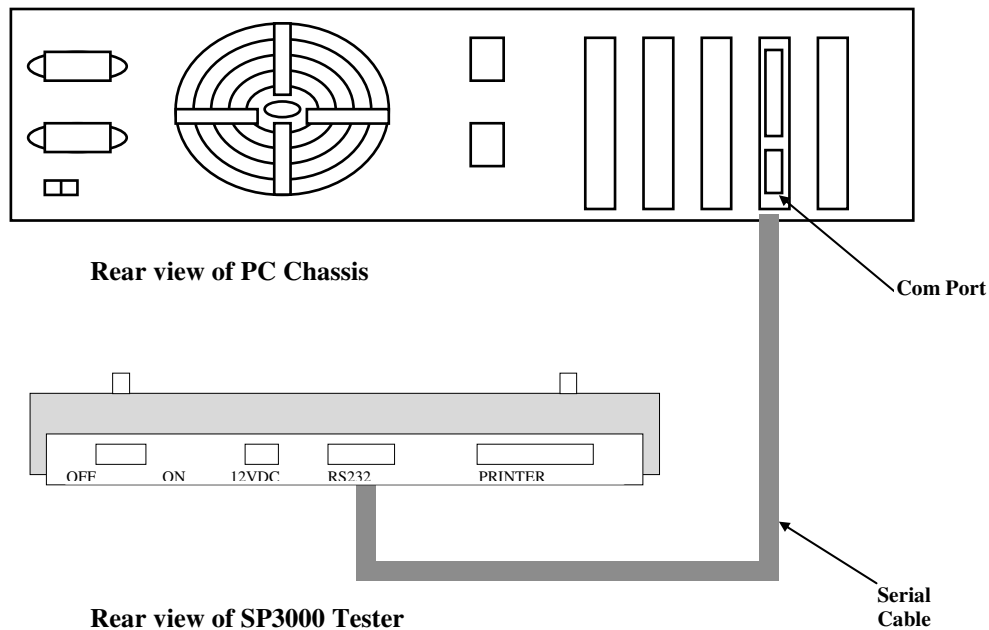
CST often release new firmware updates every 6 months for all of the adapters especially for the newer DDR3 adapter. When an upgrade is necessary, you will be notified by CST.

### Installing firmware

**Step 1:** You need to purchase PC Kit from CST, a kit consist of a PC software and a RS232 Communication cable.

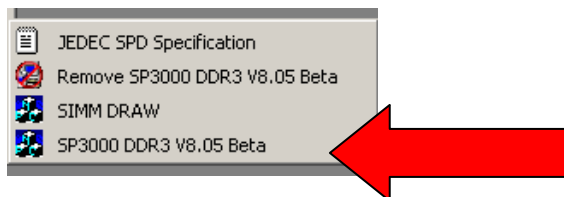
**Step 2:** Install the PC software and connect the SP3000 to the PC RS232 Port.

Connect the Serial (RS232) cable, with DB9 pin connector to the **SP3000's RS232** port located at the rear of the tester, the other end of the connector is connected to an available Com Port on your PC.



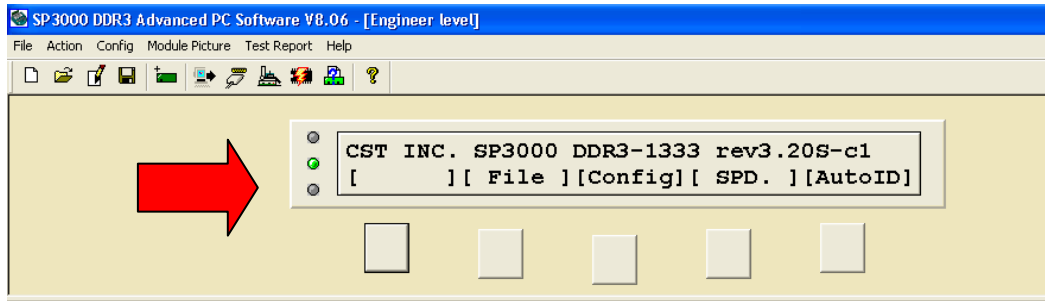
### SP3000 PC Interface Control Setup.

**Step 3:** Double click on the SP3000 PC Control icon brings up the Startup Screen displaying the information and version of the SP3000 PC software.



At this point, if the hardware connection and software interface has been setup correctly, what you see on the tester LCD screen will be simultaneously displayed on the PC software. communication setup

**Step 4:** The SP3000 tester has detected the PC software and the following window will appear.



#### **Step 5 Load Flash**



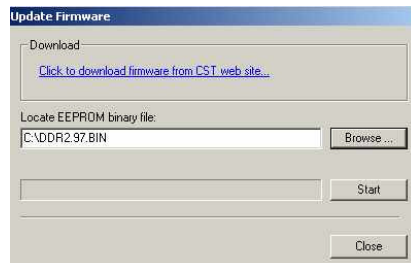
This option allows for a selection for a flash download to update new Firmware releases on the SP3000 DDR3 Tester.

This is a quick way to re-program the firmware version on the Flash EEPROM of the SP3000 tester for any new firmware releases. New firmware releases for upgrade of your existing SP3000 tester will be delivered in a 3.5" floppy diskette or by email. Alternatively, you may choose to download the firmware from CST's website at **www.simmtester.com**. To do this, store it in a PC Hard-Disk and download into the SP3000 EEPROM.



Click the icon and make sure the SP3000 is connected to the PC using the serial (RS232) cable. The communication baud rate speed has to be set correctly for proper communication interfacing with the SP3000. The SP3000 PC software has an automatic Com Port scanning software to determine the baud rate and locate an available Com Port on your PC.

After the selection, it will take you to the Open Flash EEPROM File screen as shown in Figure to select the Firmware to download. All DDR3 Firmware are coded as **DDR3. XX.BIN**

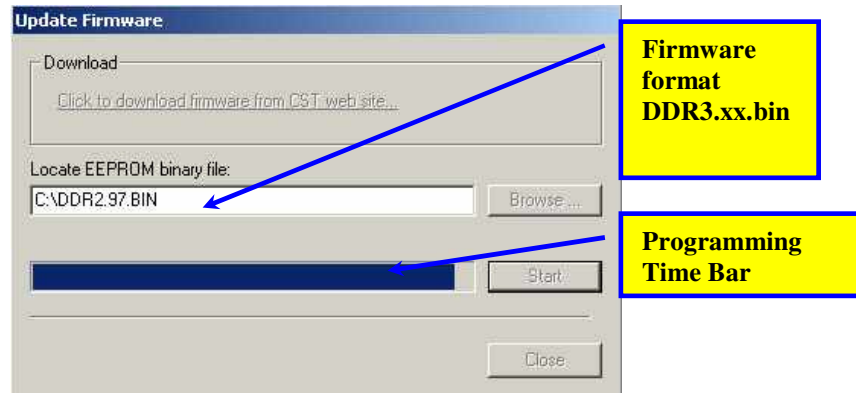


Once the file is selected, and the OK button activated, you will find a warning message. If the selected file is to download is incorrect, it will cause the SP3000 system to erase and be non-operational.



Please note that you should never interrupt the programming cycle until the programming is completed and the screen message shows Programming Complete

*Complete Flash download time takes approximately 2 minutes.*  
Interruption will cause the SP3000 system to be erased and being non-functional



**Step : 6** The SP3000 DDR3 Tester display will prompt "Programming Completed" on successful attempt and a SP3000 Reboot is necessary to verify if Flash upgrade have been successful.

